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COVER SHEET
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To the Honorable Commission



100986266

and the attached original documents or copy thereof.

1. Name of conveying party(ies):

SPUTTERED FILMS, INC.

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of conveyance:

☐ Assignment

☐ Merger

☒ Security Agreement

☐ Change of Name

☐ Other

Execution Date: As of March 4, 1999

2. Name and address of receiving party(ies):

Name: FINOVA CAPITAL CORPORATION

Internal Address: 355 S. Grand Avenue

Street Address:

City: Los Angeles State: CA ZIP: 90071

Additional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

See attached Schedule 1

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Robert D. Goldschein

Internal Address: Katten Muchin & Zavis

1999 Avenue of the Stars

Street Address:

City: Los Angeles State: CA ZIP: 90067

6. Total number of applications and patents involved: 7

7. Total fee (37 CFR 3.41): \$ 280 E

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

03/15/1999 JMWTKINS 00000114 4522697

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert D. Goldschein

Name of Person Signing

Robert D. Goldschein

Signature

3/9/99

Date

Total number of pages comprising cover sheet: 4

OMB No. 0851-0011 (exp. 4/94)

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PATENT

REEL: 9808 FRAME: 0010

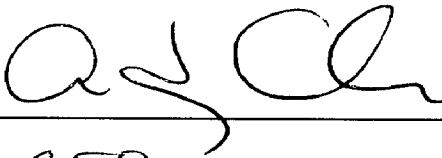
SCHEDULE 1

<u>PATENT/ SERIAL NO.</u>	<u>ISSUE/ FILING DATE</u>	<u>TITLE</u>	<u>INVENTOR(S)</u>
4,522,697	06/11/85	WATER PROCESSING MACHINE	JACK DIMLOCK/ PETER J. CLARKE
4,523,985	06/18/85	WAFER PROCESSING MACHINE	JACK A. DIMLOCK
5,766,426	06/16/98	APPARATUS FOR, AND METHOD OF, DEPOSITING A FILM ON A SUBSTRATE	ANDREW P. CLARKE
5,830,272	11/03/98	SYSTEM FOR AND METHOD OF PROVIDING A CONTROLLED DEPOSITION ON WAFERS	ROBERT G. BEGIN/ PETER J. CLARKE
5,759,268	11/03/98	SYSTEM FOR AND METHOD OF PROVIDING A CONTROLLED DEPOSITION ON WAFERS	ROBERT G. BEGIN/ PETER J. CLARKE
5,858,101	01/12/99	SYSTEM FOR AND METHOD OF PROVIDING A CONTROLLED DEPOSITION ON WAFERS	ROBERT G. BEGIN/ PETER J. CLARKE
5,865,969	02/02/99	APPARATUS FOR, AND METHOD OF, PROVIDING A DEPOSITION ON A SUBSTRATE	PETER J. CLARKE

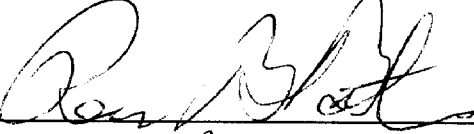
**AMENDMENT TO
PATENT SECURITY AGREEMENT**

This Amendment is made as of this 4th day of March, 1999 by SPUTTERED FILMS, INC., a California corporation ("SFI") and FINOVA CAPITAL CORPORATION ("FINOVA"), with respect to that certain Patent Security Agreement executed by SFI in favor of FINOVA and recorded with the United States Patent and Trademark Office on November 3, 1997 in Reel 8766, Frame 0855 (the "Agreement"). The Agreement is hereby amended to add the patents listed on Schedule 1 hereto to Schedule A to the Agreement. Except as so amended, the Agreement shall remain in full force and effect, and is hereby ratified and reaffirmed.

SPUTTERED FILMS, INC.

By: 
Its: CEO

FINOVA CAPITAL CORPORATION

By: 
Its: Vice President

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